

# FAST RECOVERY DIODE

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**TVRIJ** 600V 0.5A

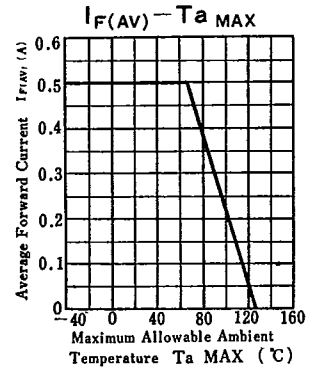
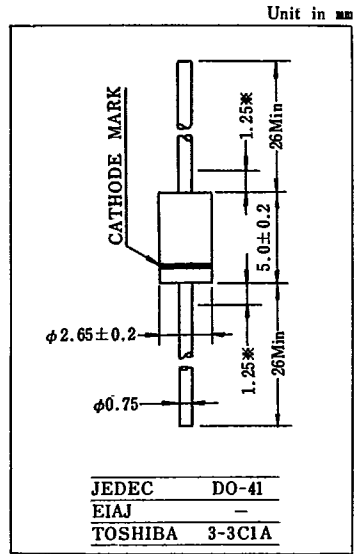
## MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	RATING	UNIT
Repetitive Peak Reverse Voltage	TVRIB	100	V
	TVRID	200	
	TVRIG	400	
	TVRIJ	600	
Average Forward Current	$I_{F(AV)}$	0.5	A
Peak One Cycle Surge Forward Current (Non-Repetitive)	$I_{FSM}$	10	A
Storage Temperature Range	$T_{stg}$	-40~125	°C
Junction temperature	$T_j$	-40~125	°C

## ELECTRICAL CHARACTERISTICS

CHARACTERISTIC	SYMBOL	CONDITION	MIN.	TYP.	MAX.	UNIT
Peak Forward Voltage	$V_{FM}$	$I_{FM} = 0.5A$ $T_j = 25^\circ C$	-	-	1.2	V
Repetitive Peak Reverse Current	$I_{RRM}$	$V_{RRM} = \text{Rated}$ , $T_j = 25^\circ C$	-	-	10	$\mu A$
Reverse Recovery Time	$t_{rr}$	$I_F = 20mA$ , $I_R = 1mA$ , $T_j = 25^\circ C$	-	-	2.0	$\mu s$

- Notes : 1. Soldering : 5mm is the minimum to be kept between case and soldering part.  
2. Lead Bending : 5mm is the minimum to be kept from the case when bend the lead wire.



**1S2777** 600V 0.5A

## MAXIMUM RATING

CHARACTERISTIC	SYMBOL	RATING	UNIT
Repetitive Peak Reverse Voltage	1S2775	200	V
	1S2776	400	
	1S2777	600	
Reverse Voltage	1S2775	100	V
	1S2776	300	
	1S2777	500	
Average Forward Current ( $T_a = 50^\circ C$ )	$I_{F(AV)}$	0.5	A
Peak One Cycle Surge Forward Current (Non-Repetitive)	$I_{FSM}$	30	A
Junction Temperature	$T_j$	-40~125	°C
Storage Temperature Range	$T_{stg}$	-40~125	°C

## ELECTRICAL CHARACTERISTICS

CHARACTERISTIC	SYMBOL	CONDITION	MIN.	TYP.	MAX.	UNIT
Peak Forward Voltage	$V_{FM}$	$I_{FM} = 1.0A$ , $T_j = 25^\circ C$	-	-	1.4	V
Repetitive Peak Reverse Current	$I_{RRM}$ (1)	$V_{RRM} = \text{Rated}$ , $T_j = 25^\circ C$	-	-	10	$\mu A$
	$I_{RRM}$ (2)	$V_{RRM} = \text{Rated}$ , $T_j = 125^\circ C$	-	-	300	
Reverse Recovery Time	$t_{rr}$ (1)	$I_F = 20mA$ , $I_R = 1mA$ , $T_j = 25^\circ C$	-	-	8.0	$\mu s$
	$t_{rr}$ (2)	$I_F = 10mA$ , $I_R = 10mA$ , $T_j = 25^\circ C$	-	-	2.0	
Forward Recovery Voltage	$V_{fr}$	$I_F = 0.1A$ , $t_r = 100ns$ , $t_p = 5\mu s$ , $T_j = 25^\circ C$	-	-	6.0	V

- Notes : 1. Soldering : 5mm is the minimum to be kept between case and soldering part.  
2. Lead Bending : 5mm is the minimum to be kept from the case when bend the lead wire.

